



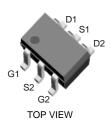
#### **DUAL P-CHANNEL ENHANCEMENT MODE FIELD EFFECT TRANSISTOR**

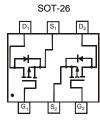
### Features

- Dual P-Channel MOSFET
- Low On-Resistance
  - 150 mΩ @ V<sub>GS</sub> = -4.5V
  - 200 mΩ @ V<sub>GS</sub> = -2.5V
  - 240 m $\Omega$  @ V<sub>GS</sub> = -1.8V
- Very Low Gate Threshold Voltage  $V_{GS(th)} \le 1V$
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- Lead Free By Design/RoHS Compliant (Note 2)
- "Green" Device (Note 3)
- Qualified to AEC-Q101 standards for High Reliability

### **Mechanical Data**

- Case: SOT-26
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals Connections: See Diagram
- Terminals: Finish Matte Tin annealed over Copper leadframe.
  Solderable per MIL-STD-202, Method 208
- Marking Information: See Page 4
- Ordering Information: See Page 4
- Weight: 0.015 grams (approximate)





TOP VIEW Internal Schematic

### Maximum Ratings @T<sub>A</sub> = 25°C unless otherwise specified

Characteristic		Symbol	Value	Units
Drain-Source Voltage		V <sub>DSS</sub>	-20	V
Gate-Source Voltage		V <sub>GSS</sub>	±12	V
Drain Current (Note 1)	T <sub>A</sub> = 25°C T <sub>A</sub> = 70°C	I <sub>D</sub>	-2.0 -1.5	A
Pulsed Drain Current		I <sub>DM</sub>	-7	A

## **Thermal Characteristics**

Characteristic	Symbol	Value	Units
Total Power Dissipation (Note 1)	PD	600	mW
Thermal Resistance, Junction to Ambient	$R_{ ext{ heta}JA}$	208	°C/W
Operating and Storage Temperature Range	TJ, TSTG	-65 to +150	°C

Notes: 1. Device mounted on FR-4 PCB.

2. No purposefully added lead.

3. Diodes Inc.'s "Green" policy can be found on our website at http://www.diodes.com/products/lead\_free/index.php.

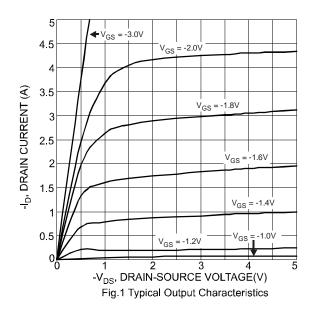


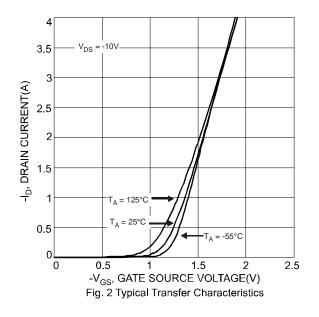
## **Electrical Characteristics** @T<sub>A</sub> = 25°C unless otherwise specified

Characteristic			Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 4)							·
Drain-Source Breakdown Voltage		<b>BV</b> <sub>DSS</sub>	-20		_	V	$V_{GS} = 0V, I_D = -250\mu A$
Zero Gate Voltage Drain Current	T <sub>J</sub> = 25°C T <sub>J</sub> = 125°C	I <sub>DSS</sub>	_	_	-1.0 -5.0	μA	$V_{DS} = -20V, V_{GS} = 0V$
Gate-Source Leakage		I <sub>GSS</sub>	_		±100	nA	$V_{GS} = \pm 12V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 4)							
Gate Threshold Voltage		V <sub>GS(th)</sub>	-0.45	_	-1.0	V	$V_{DS} = V_{GS}, I_D = -250 \mu A$
Static Drain-Source On-Resistance		R <sub>DS (ON)</sub>	_	92 134 180	150 200 240	mΩ	$\label{eq:VGS} \begin{array}{l} V_{GS} = -4.5 V, \ I_D = -2.0 A \\ V_{GS} = -2.5 V, \ I_D = -1.5 A \\ V_{GS} = -1.8 V, \ I_D = -0.5 A \end{array}$
Forward Transconductance		<b>g</b> fs	_	3.1	_	S	$V_{DS} = -10V, I_D = -810mA$
Diode Forward Voltage (Note 4)		V <sub>SD</sub>	_		-0.9	V	$V_{GS} = 0V, I_{S} = -0.5A$
DYNAMIC CHARACTERISTICS							
Input Capacitance			_	320	_	pF	
Output Capacitance		Coss	_	80	_	pF	−V <sub>DS</sub> = -16V, V <sub>GS</sub> = 0V −f = 1.0MHz
Reverse Transfer Capacitance		Crss	_	60	_	pF	
Turn-On Delay Time		t <sub>D(on)</sub>	_	11.51		ns	
Turn-On Rise Time				12.09		ns	$V_{DS} = -10V, V_{GS} = -4.5V$
Turn-Off Delay Time				55.34		ns	$R_G = 6\Omega, R_L = 10\Omega$
Turn-Off Fall Time			_	27.54		ns	1

Notes:

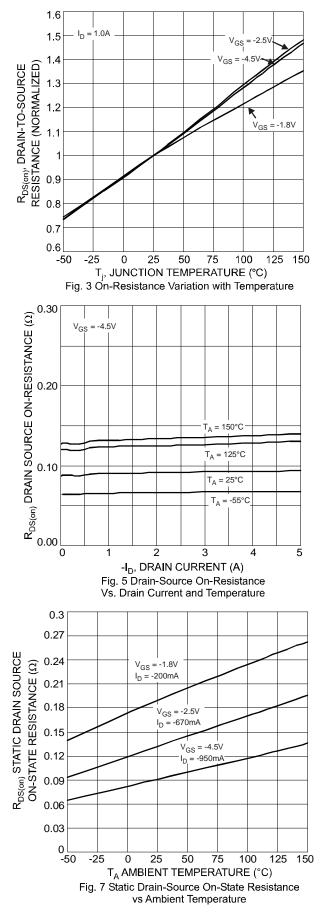
4. Short duration pulse test used to minimize self-heating effect.

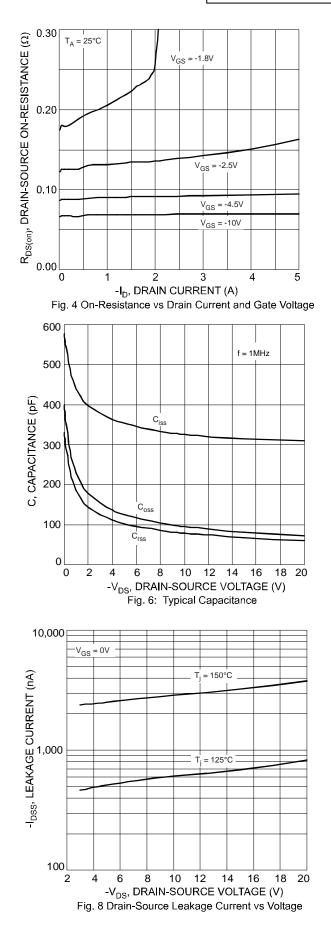






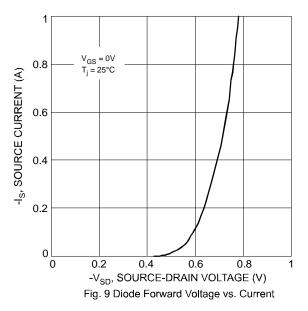






DMP2240UDM Document number: DS31197 Rev. 5 - 2 Downloaded from Arrow.com.



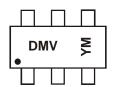


# Ordering Information (Note 5)

Part Number	Case	Packaging
DMP2240UDM-7	SOT-26	3000/Tape & Reel

Notes: 5. For packaging details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

## **Marking Information**

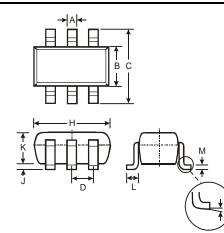


 $\begin{array}{l} \mathsf{DMV} = \mathsf{Marking} \ \mathsf{Code} \\ \mathsf{YM} = \mathsf{Date} \ \mathsf{Code} \ \mathsf{Marking} \\ \mathsf{Y} = \mathsf{Year} \ (\mathsf{ex:} \ \mathsf{U} = 2007) \\ \mathsf{M} = \mathsf{Month} \ (\mathsf{ex:} \ 9 = \mathsf{September}) \end{array}$ 

Date	Code	Kev
Dale	Coue	rtey

Year	20	07	20	08	20	09	20	10	20	11	20	12
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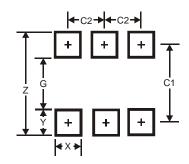
# Package Outline Dimensions



SOT-26					
Dim	Min	Max	Тур		
Α	0.35	0.50	0.38		
В	1.50	1.70	1.60		
С	2.70	3.00	2.80		
D		—	0.95		
н	2.90	3.10	3.00		
J	0.013	0.10	0.05		
κ	1.00	1.30	1.10		
L	0.35	0.55	0.40		
Μ	0.10	0.20	0.15		
α	α 0° 8° —				
All D	All Dimensions in mm				



## Suggested Pad Layout



Dimensions	Value (in mm)
Z	3.20
G	1.60
Х	0.55
Y	0.80
C1	2.40
C2	0.95

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